

Application Data Sheet

APPLICATION INFORMATION

Application Number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?:: None

Number of CD Disks:

Number of Copies of CDs::

Sequence Submission?::

Computer Readable From (CRF)?:: No

Number of Copies of CRF::

Title:: METHOD FOR MANUFACTURING
SEMICONDUCTOR DEVICE

Attorney Docket Number:: 403001

Request for Early Publication?:: No

Request for Non-Publication?:: No

Suggested Drawing Figure::

Total Drawing Sheets:: 4

Small Entity?:: No

Latin Name::

Variety denomination name::

Petition Included?:: No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers::

Secrecy Order in Parent Appl.?:: No

APPLICANT INFORMATION

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Takaaki
Middle Name::
Family Name:: KAWAHARA
Name Suffix::
City of Residence:: Tsukuba-shi
State or Prov. of Residence:: Ibaraki
Country of Residence:: Japan
Street of mailing address:: c/o Semiconductor Leading Edge
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16-1 Onogawa
City of mailing address:: Tsukuba-shi
State or Province of mailing address:: Ibaraki
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 305-0053

Inventor Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Kazuyoshi
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Family Name:: TORII
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CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 23548
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REPRESENTATIVE INFORMATION

Representative Customer Number:: 23548

Representative Designation:: Registration Number:: Representative Name::

DOMESTIC PRIORITY INFORMATION

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

FOREIGN APPLICATION INFORMATION

Country::	Application Number::	Filing Date::	Priority Claimed
Japan	2003-80007	03/24/03	Yes

ASSIGNEE INFORMATION

Assignee name:: Semiconductor Leading Edge Technologies, Inc.

Street of mailing address:: 16-1 Onogawa

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State or Province of
mailing address:: Ibaraki

Country of mailing
address:: Japan

Postal or Zip Code of
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